

ST330C..C SERIES

PHASE CONTROL THYRISTORS

Hockey Puk Version

720A

Features

- Center amplifying gate
- Metal case with ceramic insulator
- International standard case TO-200AB (E-PUK)

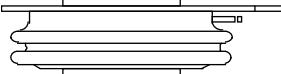
Typical Applications

- DC motor controls
- Controlled DC power supplies
- AC controllers

Major Ratings and Characteristics

Parameters	ST330C..C	Units
$I_{T(AV)}$	720	A
@ T_{hs}	55	°C
$I_{T(RMS)}$	1420	A
@ T_{hs}	25	°C
I_{TSM}	9000	A
@ 60Hz	9420	A
I^2t	405	KA²s
@ 60Hz	370	KA²s
V_{DRM}/V_{RRM}	400 to 1600	V
t_q typical	100	μs
T_J	- 40 to 125	°C

case style TO-200AB (E-PUK)



ST330C..C Series

Bulletin I25155 rev. C 04/00

International
IR Rectifier

ELECTRICAL SPECIFICATIONS

Voltage Ratings

Type number	Voltage Code	V_{DRM}/V_{RRM} , max. repetitive peak and off-state voltage V	V_{RSM} , maximum non-repetitive peak voltage V	I_{DRM}/I_{RRM} max. @ $T_J = T_{J\max}$ mA
ST330C..C	04	400	500	50
	08	800	900	
	12	1200	1300	
	14	1400	1500	
	16	1600	1700	

On-state Conduction

Parameter	ST330C..C	Units	Conditions
$I_{T(AV)}$ Max. average on-state current @ Heatsink temperature	720 (350)	A	180° conduction, half sine wave double side (single side) cooled
	55 (75)	°C	
$I_{T(RMS)}$ Max. RMS on-state current	1420	A	DC @ 25°C heatsink temperature double side cooled
I_{TSM} Max. peak, one-cycle non-repetitive surge current	9000		Sinusoidal half wave, Initial $T_J = T_{J\max}$
	9420		
	7570		
	7920		
I^2t Maximum I^2t for fusing	405	KA ² s	No voltage reapplied
	370		
	287		
	262		
$I^2\sqrt{t}$ Maximum $I^2\sqrt{t}$ for fusing	4050	KA ² /s	t = 0.1 to 10ms, no voltage reapplied
$V_{T(TO)1}$ Low level value of threshold voltage	0.91	V	(16.7% $\times \pi \times I_{T(AV)} < I < \pi \times I_{T(AV)}$), $T_J = T_{J\max}$
$V_{T(TO)2}$ High level value of threshold voltage	0.92		($I > \pi \times I_{T(AV)}$), $T_J = T_{J\max}$
r_{t1} Low level value of on-state slope resistance	0.58	mΩ	(16.7% $\times \pi \times I_{T(AV)} < I < \pi \times I_{T(AV)}$), $T_J = T_{J\max}$
r_{t2} High level value of on-state slope resistance	0.57		($I > \pi \times I_{T(AV)}$), $T_J = T_{J\max}$
V_{TM} Max. on-state voltage	1.96	V	$I_{pk} = 1810A$, $T_J = T_{J\max}$, $t_p = 10ms$ sine pulse
I_H Maximum holding current	600	mA	$T_J = 25^\circ\text{C}$, anode supply 12V resistive load
I_L Typical latching current	1000		

Switching

Parameter	ST330C..C	Units	Conditions
di/dt Max. non-repetitive rate of rise of turned-on current	1000	A/μs	Gate drive 20V, 20Ω, $t_r \leq 1\mu\text{s}$ $T_J = T_{J\max}$, anode voltage $\leq 80\%$ V_{DRM}
t_d Typical delay time	1.0	μs	Gate current 1A, $di_g/dt = 1\text{A}/\mu\text{s}$ $V_d = 0.67\% V_{DRM}$, $T_J = 25^\circ\text{C}$
t_q Typical turn-off time	100		$I_{TM} = 550A$, $T_J = T_{J\max}$, $di/dt = 40\text{A}/\mu\text{s}$, $V_R = 50V$ $dv/dt = 20\text{V}/\mu\text{s}$, Gate 0V 100Ω, $t_p = 500\mu\text{s}$

Blocking

Parameter	ST330C..C	Units	Conditions
dv/dt Maximum critical rate of rise of off-state voltage	500	V/ μ s	$T_J = T_J$ max. linear to 80% rated V_{DRM}
I_{RRM} Max. peak reverse and off-state leakage current	50	mA	$T_J = T_J$ max, rated V_{DRM}/V_{RRM} applied

Triggering

Parameter	ST330C..C	Units	Conditions
P_{GM} Maximum peak gate power	10.0	W	$T_J = T_J$ max, $t_p \leq 5ms$
$P_{G(AV)}$ Maximum average gate power	2.0		$T_J = T_J$ max, $f = 50Hz$, $d\% = 50$
I_{GM} Max. peak positive gate current	3.0	A	$T_J = T_J$ max, $t_p \leq 5ms$
+ V_{GM} Maximum peak positive gate voltage	20	V	$T_J = T_J$ max, $t_p \leq 5ms$
- V_{GM} Maximum peak negative gate voltage	5.0		
I_{GT} DC gate current required to trigger	TYP. 200 100 50	MAX. - 200 -	mA $T_J = -40^\circ C$ $T_J = 25^\circ C$ $T_J = 125^\circ C$ Max. required gate trigger/ current/voltage are the lowest value which will trigger all units 12V anode-to-cathode applied
V_{GT} DC gate voltage required to trigger	2.5 1.8 1.1	- 3.0 -	V $T_J = -40^\circ C$ $T_J = 25^\circ C$ $T_J = 125^\circ C$
I_{GD} DC gate current not to trigger	10	mA	
V_{GD} DC gate voltage not to trigger	0.25	V	$T_J = T_J$ max Max. gate current/voltage not to trigger is the max. value which will not trigger any unit with rated V_{DRM} anode-to-cathode applied

Thermal and Mechanical Specification

Parameter	ST330C..C	Units	Conditions
T_J Max. operating temperature range	-40 to 125	$^\circ C$	
T_{stg} Max. storage temperature range	-40 to 150		
R_{thJ-hs} Max. thermal resistance, junction to heatsink	0.09 0.04	K/W	DC operation single side cooled DC operation double side cooled
R_{thC-hs} Max. thermal resistance, case to heatsink	0.02 0.01	K/W	DC operation single side cooled DC operation double side cooled
F Mounting force, $\pm 10\%$	9800 (1000)	N (Kg)	
wt Approximate weight	83	g	
Case style	TO - 200AB (E-PUK)		See Outline Table

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ΔR_{thJ-hs} Conduction

(The following table shows the increment of thermal resistance R_{thJ-hs} when devices operate at different conduction angles than DC)

Conduction angle	Sinusoidal conduction		Rectangular conduction		Units	Conditions
	Single Side	Double Side	Single Side	Double Side		
180°	0.012	0.011	0.008	0.007	K/W	$T_J = T_{J \max}$
120°	0.014	0.012	0.014	0.013		
90°	0.017	0.015	0.019	0.017		
60°	0.025	0.022	0.026	0.023		
30°	0.043	0.036	0.043	0.037		

Ordering Information Table

Device Code	
ST	330C16C1
1	2
3	4
5	6
7	8

1 - Thyristor
2 - Essential part number
3 - 0 = Converter grade
4 - C = Ceramic Puk
5 - Voltage code: Code x 100 = V_{RRM} (See Voltage Rating Table)
6 - C = Puk Case TO-200AB (E-PUK)
7 - 0 = Eyelet terminals (Gate and Auxiliary Cathode Unsoldered Leads)
 1 = Fast-on terminals (Gate and Auxiliary Cathode Unsoldered Leads)
 2 = Eyelet terminals (Gate and Auxiliary Cathode Soldered Leads)
 3 = Fast-on terminals (Gate and Auxiliary Cathode Soldered Leads)
8 - Critical dv/dt: None = 500V/ μ sec (Standard selection)
 L = 1000V/ μ sec (Special selection)

Outline Table

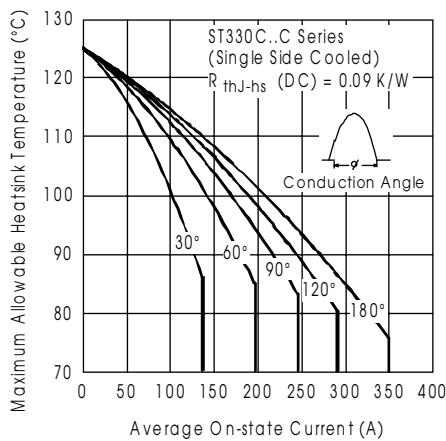
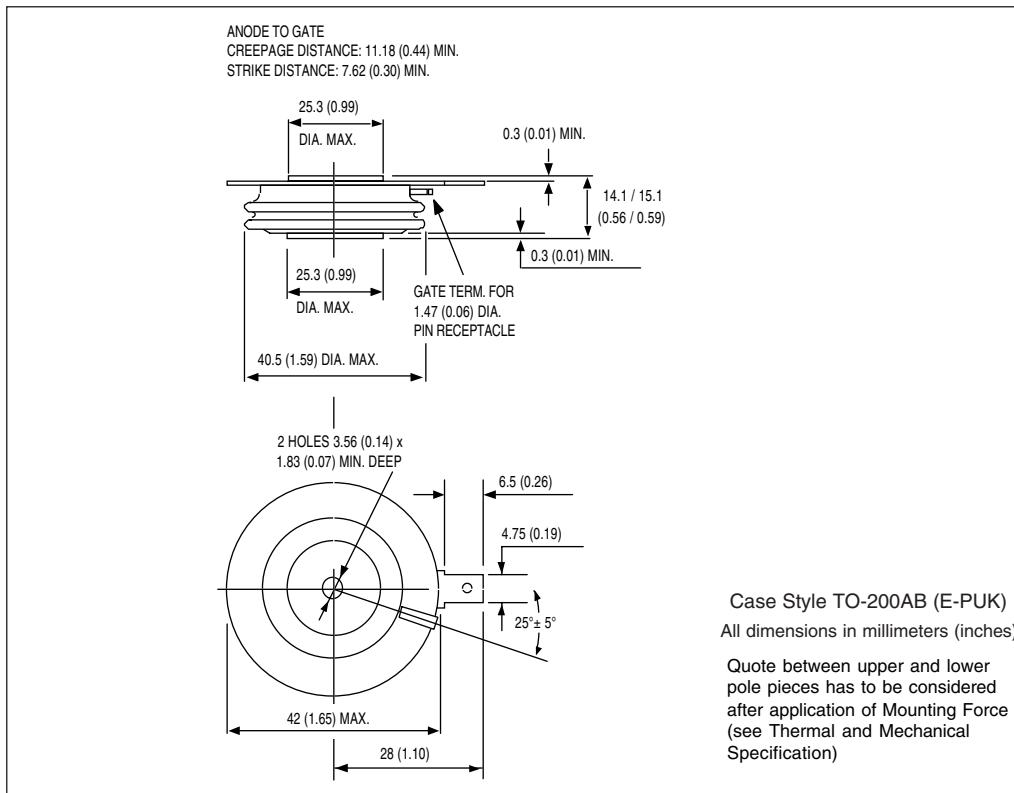


Fig. 1 - Current Ratings Characteristics

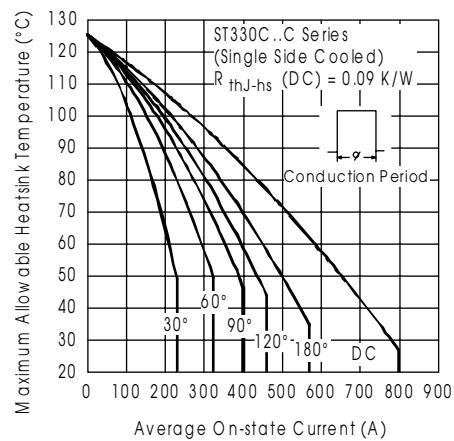


Fig. 2 - Current Ratings Characteristics

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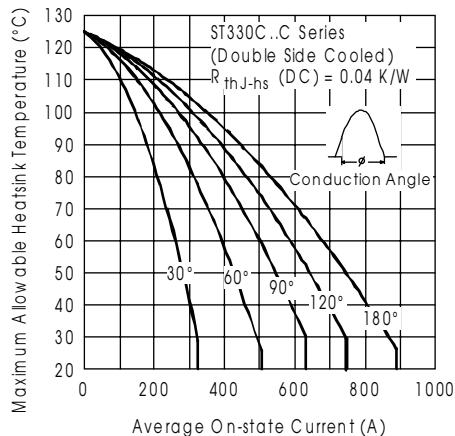


Fig. 3 - Current Ratings Characteristics

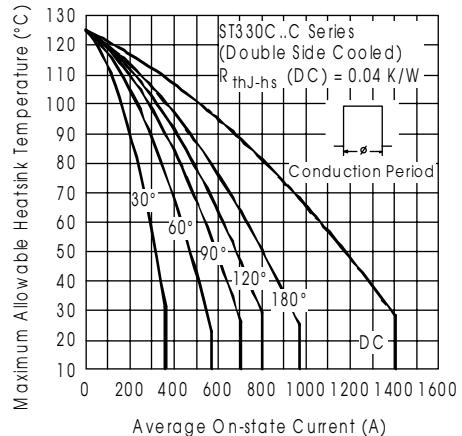


Fig. 4 - Current Ratings Characteristics

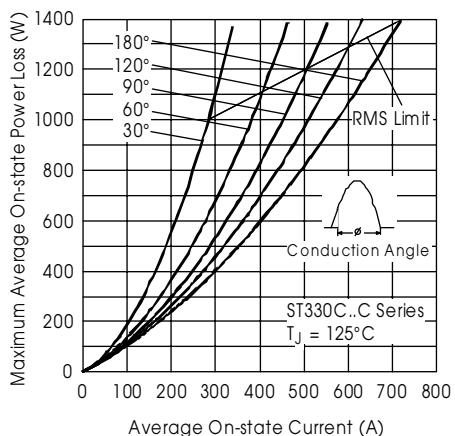


Fig. 5 - On-state Power Loss Characteristics

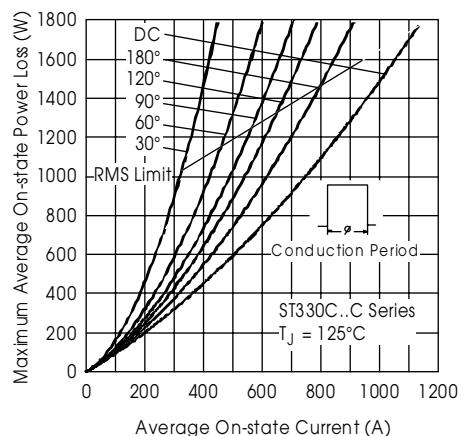


Fig. 6 - On-state Power Loss Characteristics

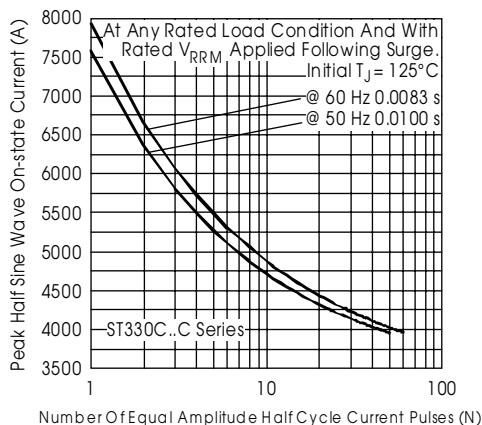


Fig. 7 - Maximum Non-Repetitive Surge Current
Single and Double Side Cooled

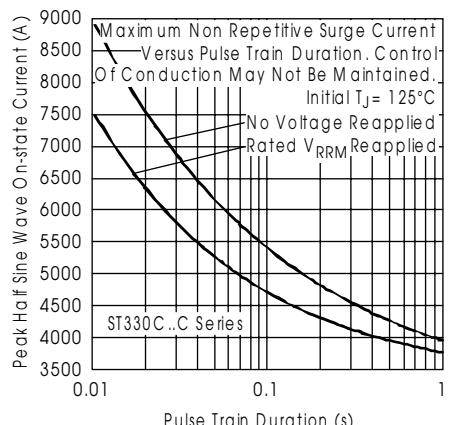


Fig. 8 - Maximum Non-Repetitive Surge Current
Single and Double Side Cooled

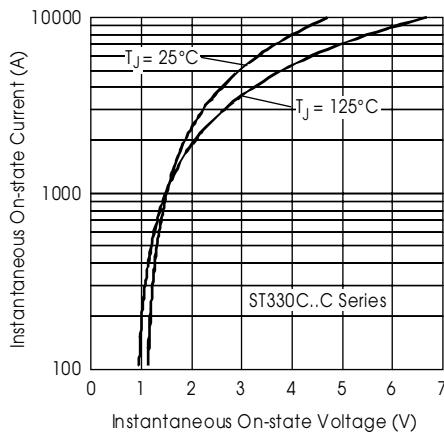


Fig. 9 - On-state Voltage Drop Characteristics

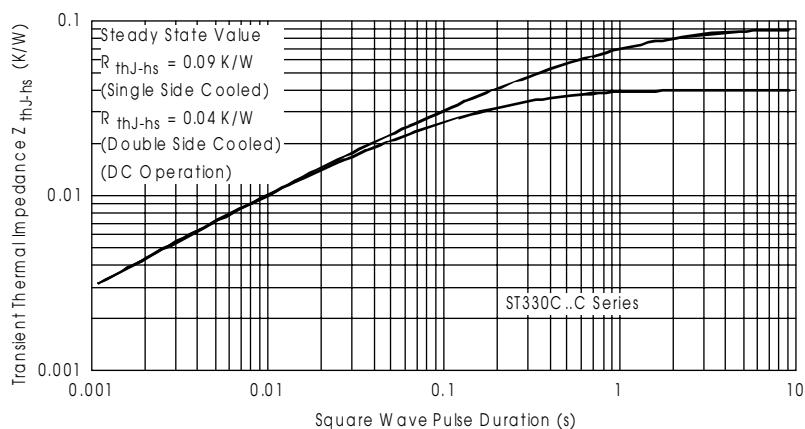


Fig. 10 - Thermal Impedance Z_{thJ-hs} Characteristics

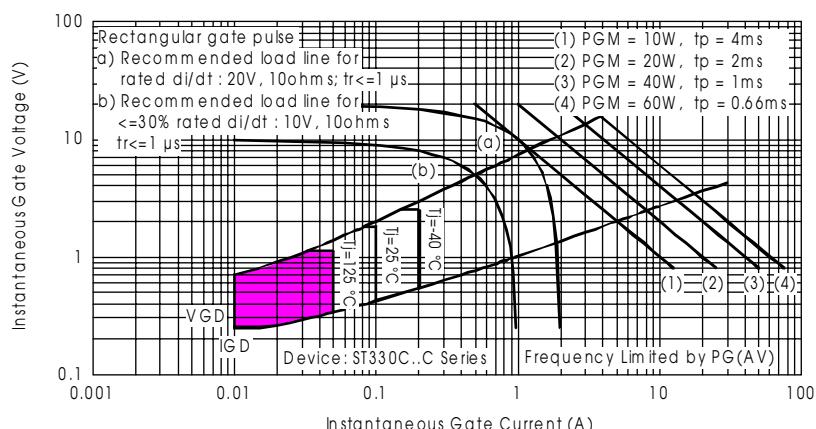


Fig. 11 - Gate Characteristics



**Стандарт
Электрон
Связь**

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